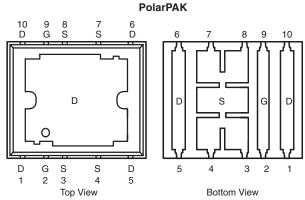


Vishay Siliconix

N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)		
150	0.038 at V _{GS} = 10 V	37	46 nC		
	0.040 at $V_{GS} = 6 \text{ V}$	36	40110		

Package Drawing www.vishay.com/doc?64713



Top surface is connected to pins 1, 5, 6, and 10

Ordering Information: SiE804DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

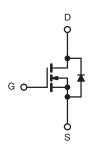
- Halogen-free According to IEC 61249-2-21
- TrenchFET[®] Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling



- · Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size, > 100 V
- 100 % R_a and UIS Tested

APPLICATIONS

- Primary Side Switch
- · Half-Bridge



N-Channel MOSFET For Related Documents www.vishay.com/ppg?69091

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	150	V	
Gate-Source Voltage		V_{GS}	± 20		
	T _C = 25 °C		37		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		29		
Continuous Diain Current (1) = 150 C)	T _A = 25 °C	l _D	7.5 ^{b, c}		
	T _A = 70 °C		6 ^{b, c}	•	
Pulsed Drain Current		I _{DM}	50	A	
Continuous Course Drain Diade Current	T _C = 25 °C		37		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	4.3 ^{b, c}		
Single Pulse Avalanche Current	1 - 0.1 mH	I _{AS}	25		
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	62	mJ	
	T _C = 25 °C		125		
Maximum Dawar Dissination	T _C = 70 °C	P _D	80	w	
Maximum Power Dissipation	T _A = 25 °C	LD	5.2 ^{b, c}	VV	
	T _A = 70 °C		3.3 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

Notes:

- a. $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. See Solder Profile (www.vishay.com/doc?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R_{thJA}	20	24		
Maximum Junction-to-Case (Drain Top)	Steady State	R _{thJC} (Drain)	0.8	1	°C/W	
Maximum Junction-to-Case (Source)a, c	Sieddy State	R _{thJC} (Source)	2.2	2.7		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Maximum under Steady State conditions is 68 °C/W.
- c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		175		m\//°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 7		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS} -	V _{DS} = 150 V, V _{GS} = 0 V			1	μΑ	
		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α	
Dunin Course On State Besistance	B	$V_{GS} = 10 \text{ V, I}_{D} = 7.6 \text{ A}$		0.031	0.038	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 6 \text{ V}, I_D = 7.4 \text{ A}$		0.032	0.040		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 7.6 \text{ A}$		40		S	
Dynamic ^b							
Input Capacitance	C _{iss}			3000		pF	
Output Capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		210			
Reverse Transfer Capacitance	C _{rss}			110			
Total Gata Charge	Q _g	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 7.6 \text{ A}$		70	105	nC	
Total Gate Charge				46	70		
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 6 \text{ V}, I_D = 7.6 \text{ A}$		11			
Gate-Drain Charge	Q _{gd}			19			
Gate Resistance	R_g	f = 1 MHz		2.1	4.2	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = 75 V, R_L = 12.5 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 6 \text{ A}, V_{GEN} = 6 \text{ V}, R_g = 1 \Omega$		40	60		
Fall Time	t _f			12	20	20	
	t _{d(on)}			15	25	ns	
Switching Time	t _r	$V_{DD} = 75 \text{ V}, R_{L} = 12.5 \Omega$ $I_{D} \cong 6 \text{ A}, V_{GEN} = 10 \text{ V}, R_{g} = 1 \Omega$		10	15		
Switching Time	t _{d(off)}			42	65		
	t _r			10	10 15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			37	А	
Pulse Diode Forward Current ^a	I _{SM}				25		
Body Diode Voltage	V _{SD}	I _S = 6 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			70	110	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$I_F = 6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		220	330	nC	
Reverse Recovery Fall Time	ta	$I_F = 0$ A, $UI/UI = 100$ A/ μ S, $I_J = 25$ °C		54		ns	
Reverse Recovery Rise Time	t _b			16			

Notes:

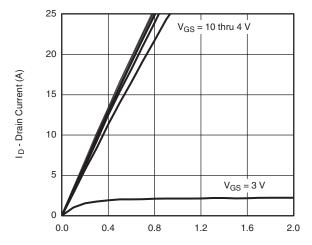
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



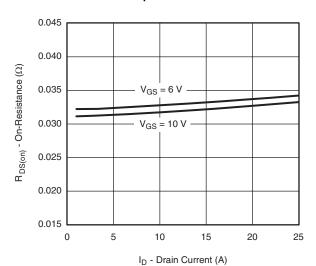
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

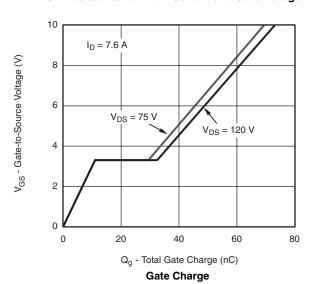


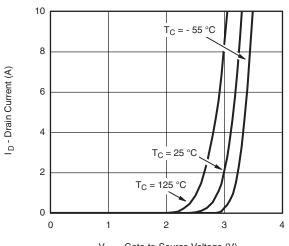
V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics



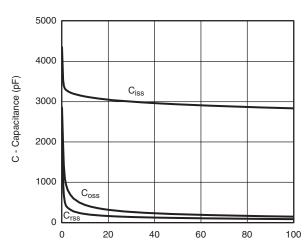
On-Resistance vs. Drain Current and Gate Voltage





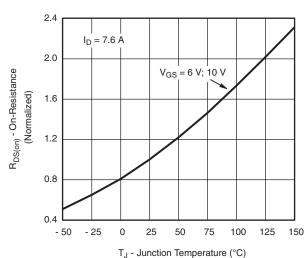
V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



 V_{DS} - Drain-to-Source Voltage (V)

Capacitance

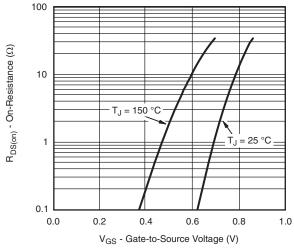


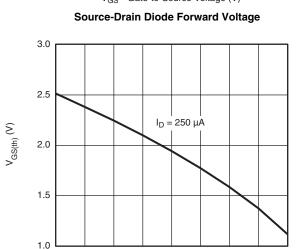
ij - Junction Temperature (C)

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





T_J - Temperature (°C)

Threshold Voltage

50

75

100

125

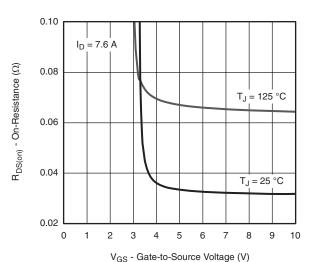
150

25

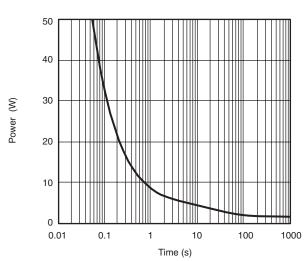
0

- 25

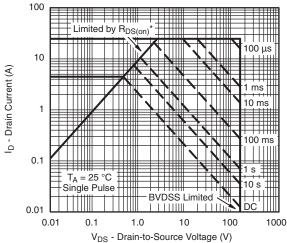
- 50



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



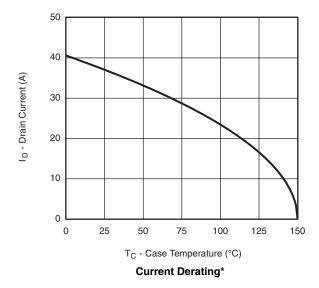
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

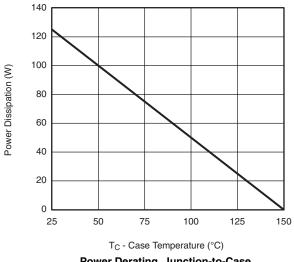
Safe Operating Area, Junction-to-Ambient



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





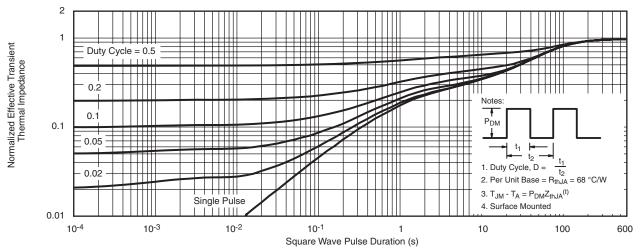
Power Derating, Junction-to-Case

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

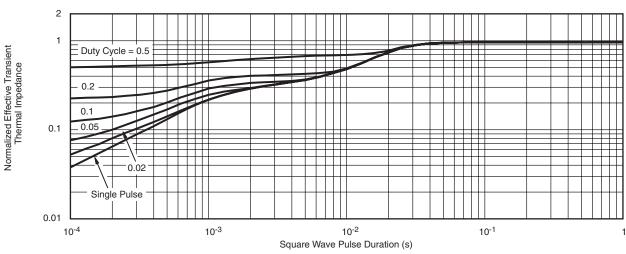
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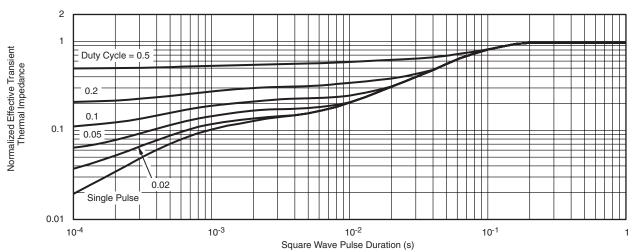
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case (Drain Top)



Normalized Thermal Transient Impedance, Junction-to-Source

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69091.



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